

SECTION I
LIST OF MANUFACTURERS' QUALIFIED CAPABILITIES FOR EACH TECHNOLOGY

MANUFACTURER INFORMATION: FTG Circuits Haverhill Inc 140 Hilldale Avenue, Haverhill, MA, 01832		CAGE Code: 78259 Phone: 978-373-9190 Fax: 978-521-1846 EMail: sales@imipcb.com
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CAPABILITIES BY TECHNOLOGY/ASSOCIATED SPECIFICATION

Specification: MIL-PRF-31032/1, MIL-PRF-31032/2
Qualification Letters: VQ(VQE-17-031308)
Composition: S - Homogenous thermosetting base material printed boards
Rigid Base Material: GF: Woven E-Glass, Epoxy Resin, Flame Resistant
Max. Panel Size: 16" x 18"
Max. Number of Layers: 10
Max. Board Thickness: .11"
Min. Hole Size: .01" Drilled Plated-Through Hole Before Plating
Aspect Ratio: 12.5:1 Through-Hole
Min. Conductor Width/Space: .005"/.005"
Hole Preparation: Permanganate Desmear
Hole Wall Conductive Coating: Electroless Copper
Copper Plating: Direct Current Plate
Solder Resist: Liquid Photoimageable
Finish System: HASL